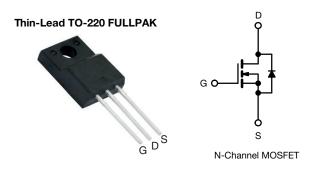
SiHA24N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.160				
Q _g max. (nC)	89				
Q _{gs} (nC)	15				
Q _{gd} (nC)	30				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA24N80AE-GE3				

ABSOLUTE MAXIMUM RATINGS	(:0 =0 0, 0				-	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	v	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current (T _J = 150 °C) $^{\circ}$ C)	Vec at 10 V	T _C = 25 °C T _C = 100 °C	I _D	9		
	VGS at 10 V	T _C = 100 °C		5	А	
Pulsed drain current ^a			I _{DM}	51	1	
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	127	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		T _J = 125 °C	alı . (alt	70	1//	
Reverse diode dv/dt d			dv/dt	34	V/ns	
Soldering recommendations (peak temperature	e) c	For 10 s		260	°C	
Mounting torque, M3 screw		•		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65					
Maximum junction-to-case (drain)	R _{thJC}	-	- 3.6			°C/W			
	•								
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)							
PARAMETER	SYMBOL		T CONDITI	ONS	MIN.	TYP.	MAX.	UNI	
Static							I		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	800	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.8	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 2		2	-	4	V	
		-	$V_{GS} = \pm 20$ V		-	-	± 100	nA	
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 \	/	-	-	± 1	μA	
7			= 800 V, V _{GS}		-	-	1		
Zero gate voltage drain current	IDSS			T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	1	= 10 A	-	0.160	0.184	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D =	12 A	-	5.5	-	S	
Dynamic					•	•			
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1836	-	pF		
Output capacitance	C _{oss}			-	65	-			
Reverse transfer capacitance	C _{rss}			-	5	-			
Effective output capacitance, energy related	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	52	-			
Effective output capacitance, time related	C _{o(tr)}			-	338	-			
Total gate charge	Qg	V _{GS} = 10 V I _D = 12 A, V _{DS} = 640 V		-	59	89	nC		
Gate-source charge	Q _{gs}			-	15	-			
Gate-drain charge	Q _{gd}				-	30	-	1	
Turn-on delay time	t _{d(on)}				-	21	42		
Rise time	t _r	V _{DD} =	V _{DD} = 640 V, I _D = 12 A,		-	44	88	1	
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	29	58	- ns		
Fall time	t _f			-	51	102			
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω		
Drain-Source Body Diode Characteris	lics					•			
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21			
Pulsed diode forward current	I _{SM}			-	-	51	A		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 12 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	476	952	ns		
Reverse recovery charge	Q _{rr}			-	7.8	15.6	μC		
Reverse recovery current	I _{RRM}			-	26	-	A		



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

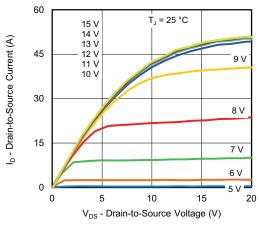


Fig. 1 - Typical Output Characteristics

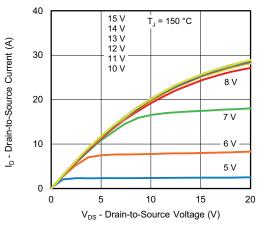


Fig. 2 - Typical Output Characteristics

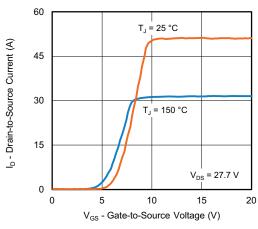


Fig. 3 - Typical Transfer Characteristics

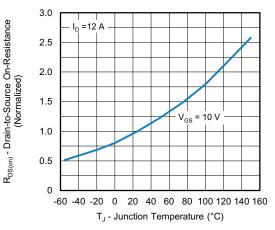


Fig. 4 - Normalized On-Resistance vs. Temperature

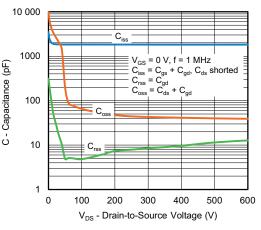
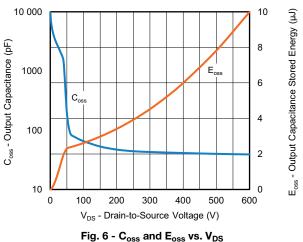


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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3 For technical questions, contact: hvm@vishay.com Document Number: 92371

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SiHA24N80AE

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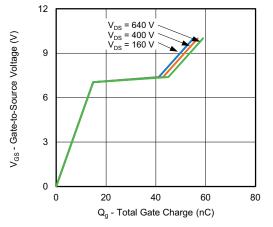


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

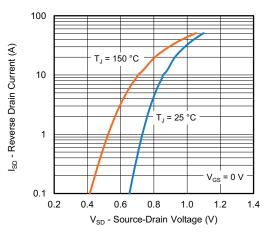


Fig. 8 - Typical Source-Drain Diode Forward Voltage

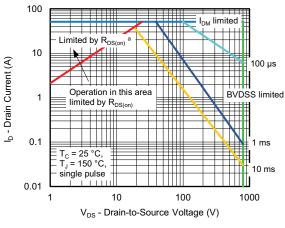


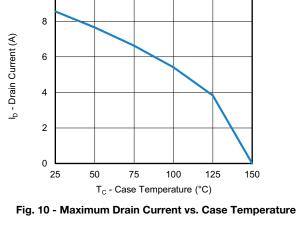
Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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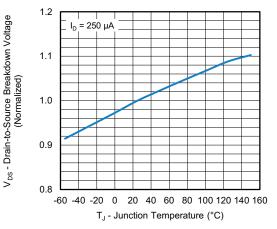


Fig. 11 - Temperature vs. Drain-to-Source Voltage

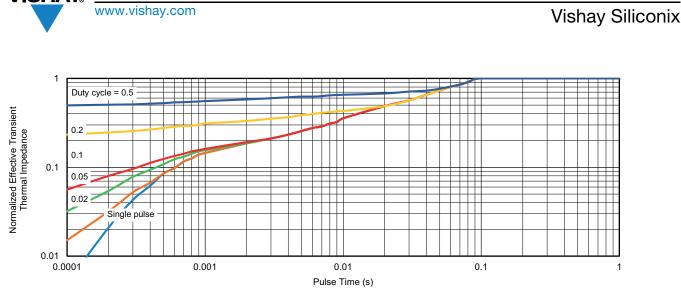


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

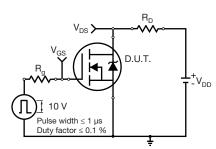


Fig. 13 - Switching Time Test Circuit

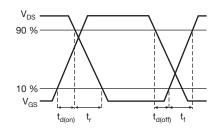


Fig. 14 - Switching Time Waveforms

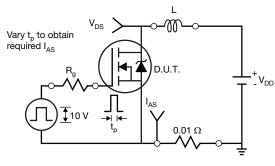
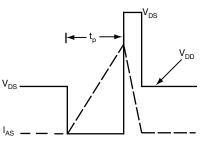


Fig. 15 - Unclamped Inductive Test Circuit



SiHA24N80AE

Fig. 16 - Unclamped Inductive Waveforms

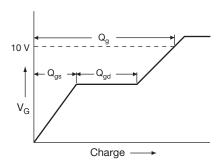
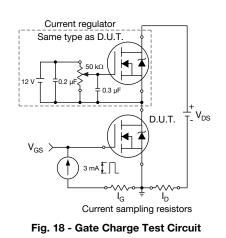


Fig. 17 - Basic Gate Charge Waveform



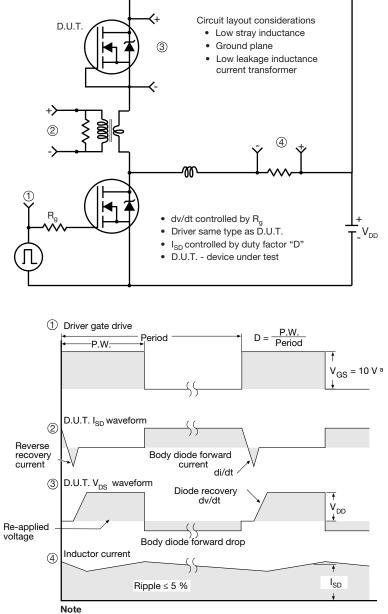
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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